

Intel® Network Builders Insights Series

Intel System-on-a Chip (SoC) Overview

- Xiaojun (Shawn) Li, Sales Director, Next Wave OEM & eODM
- Vinila Yarlagadda, Product Manager and Business Operations – System-on-a Chip (SoC) Platforms



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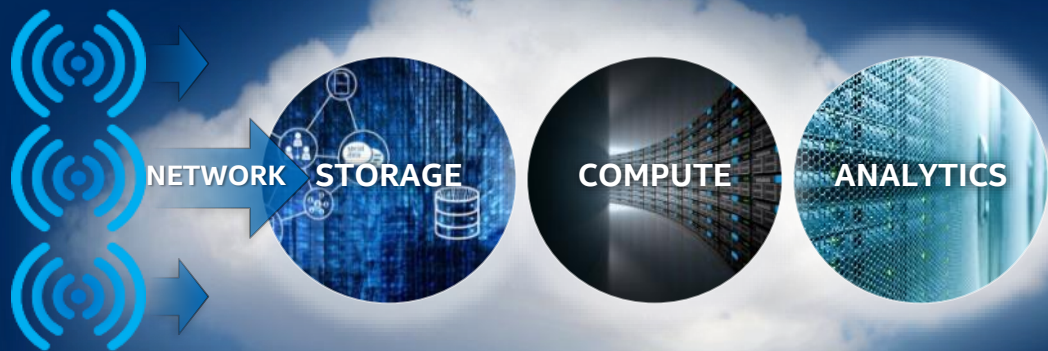
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What is happening to the Network?

2005-2016

2019+

THINGS



THINGS

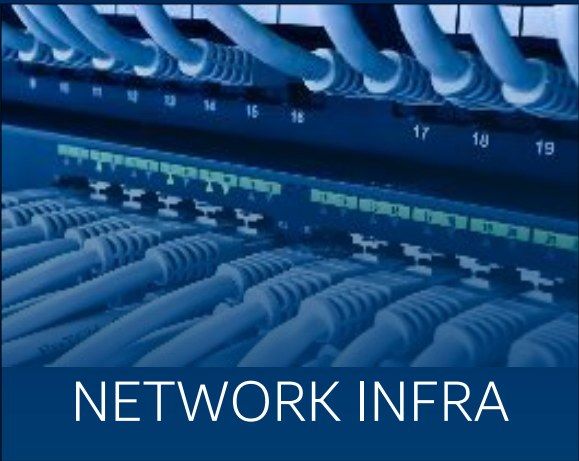
EDGE

NETWORK CORE

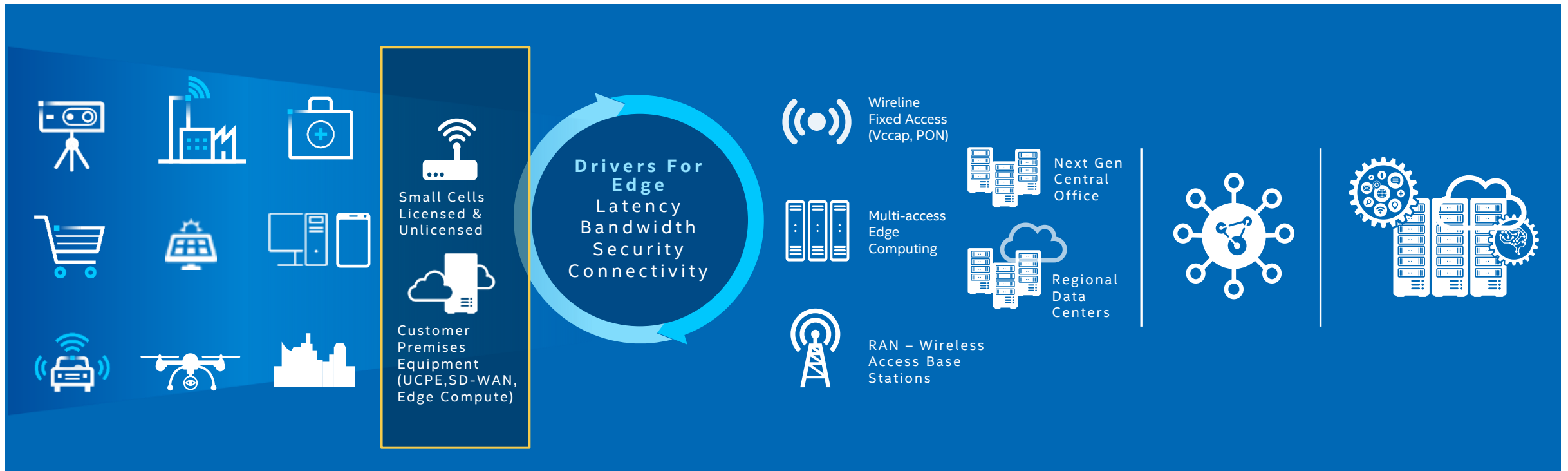
CLOUD



Security is Foundational to Network Transformation



Drivers of Edge Computing



Devices/Things

Enterprise Edge

Network Edge

Core Network

Cloud Data Center

Latency expectation **Varies <1 ms**

<5 ms

<10-40 ms

< 60 ms

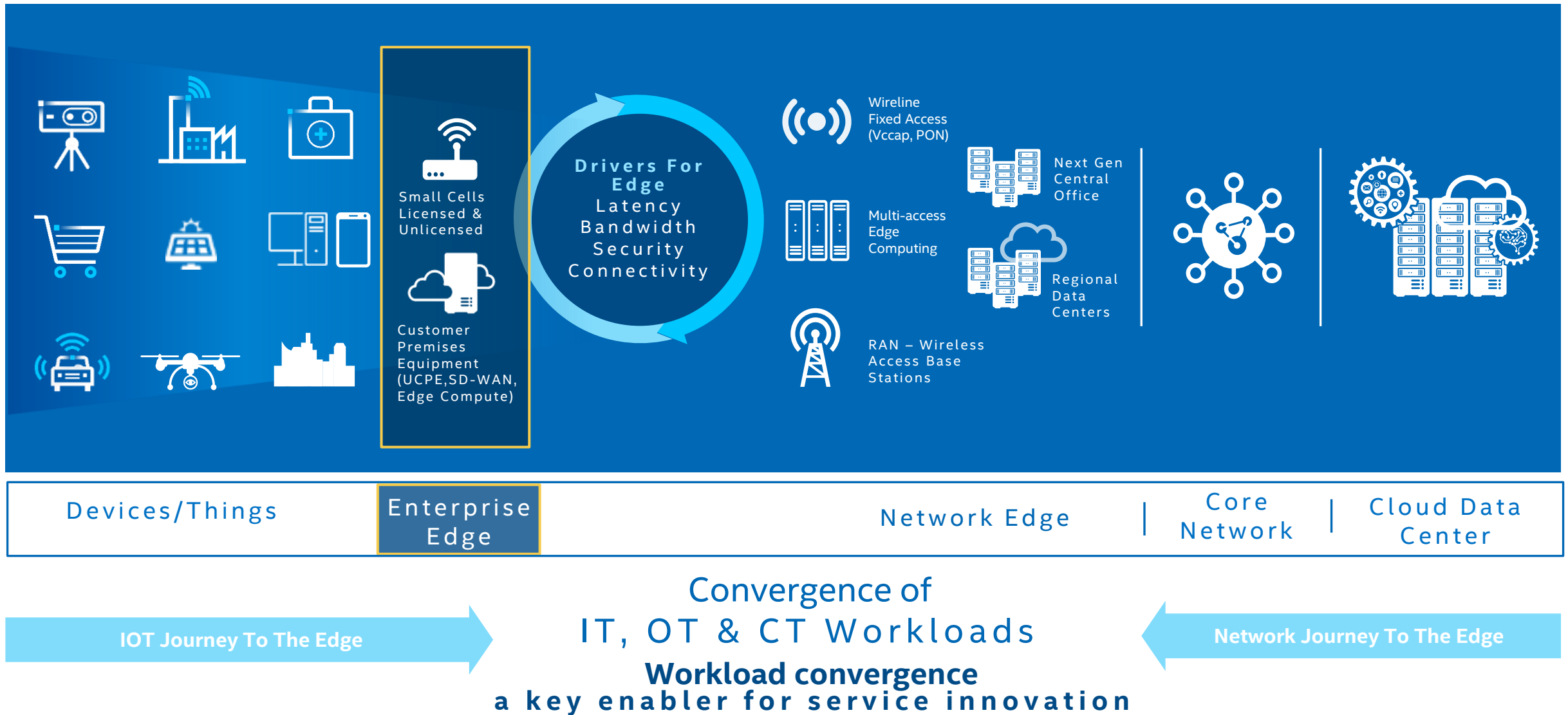
~100 ms

Flexibility to run workloads on-prem, at the network edge, or in the data center/cloud.

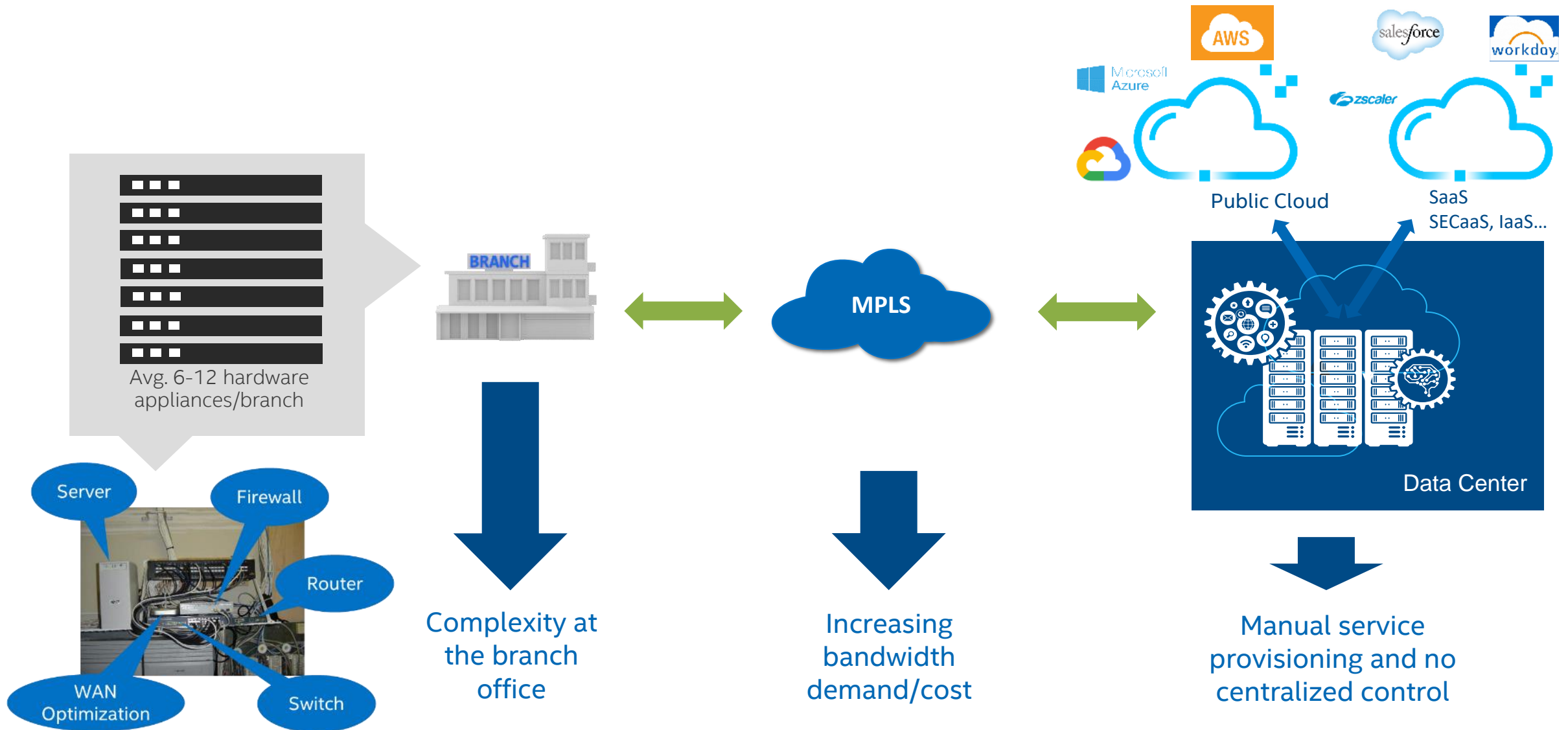
Enable low latency apps, e.g. Power backbone disconnect (<4ms), high speed machinery cut-off (1ms), Surveillance camera feed analysis (2ms)

1. Gartner; <https://www.gartner.com/smarterwithgartner/what-edge-computing-means-for-infrastructure-and-operations-leaders>

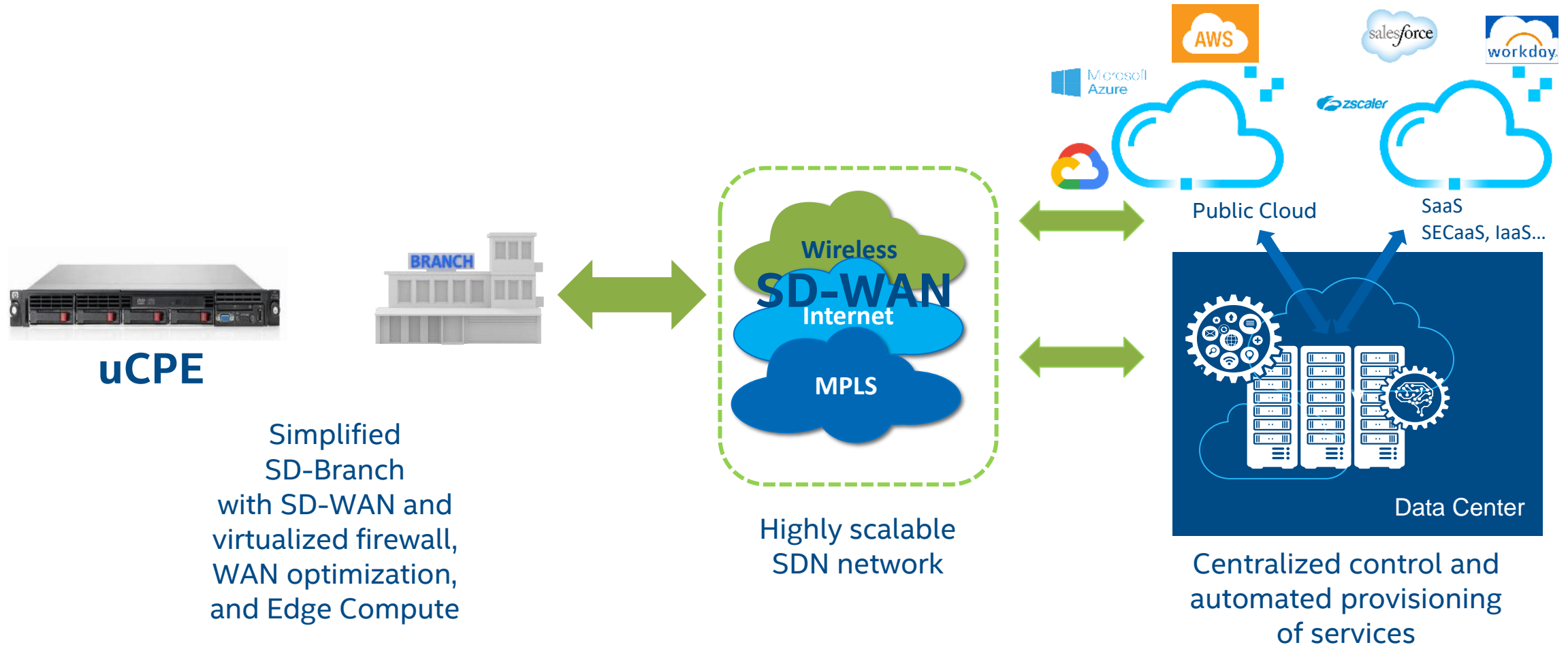
Workload Convergence at the Enterprise Edge



Enterprise Branch Offices are Complex...



Transformation to the SD-Branch



Three Forces Impacting Network Security

EXPANSION of Attack Surface



Billions of connected devices and the move to the cloud

INDUSTRIALIZATION of Hacking



Criminal **sophistication** and evolving intent to get to your **data**

FRAGMENTATION of Solutions



Thousands of products from **hundreds** of vendors

5G/Edge is software centric transformation

Open Source, Open architecture pose the new security challenge

EXPANSION of Attack Surface



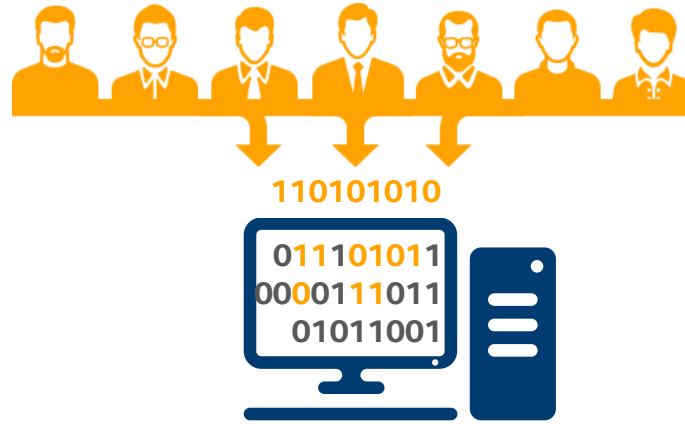
Workload
Convergence

Intel® Architecture
Performance + Scale



Transform the networking infrastructure with Cloud Model for Lower TCO. Optimize R&D on Intel Modular Technologies

MULTI PARTY Of Trust Computation



Secure infrastructure for NFV, Edge service requires IP, data protection, workload isolation and resource partition

Ease Access Of Malicious Attacker



Remote deployment, the rising edge computing, Security is a critical priority to assure the service always-on

Network & Security Appliance Market

Transformation to Multi-cloud workload consolidation

Customer Challenges

- Hardware mgmt. complexity & interoperability
- IT knowledge & lack of cloud network expertise
- Low price point and TCO

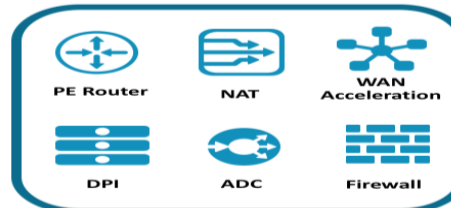
Our Strategy

- Strong SW ecosystem
- Multi-Cloud enabling
- SoCs with competitive price points w/ virtualization and scalability

Fixed Function Network Appliances



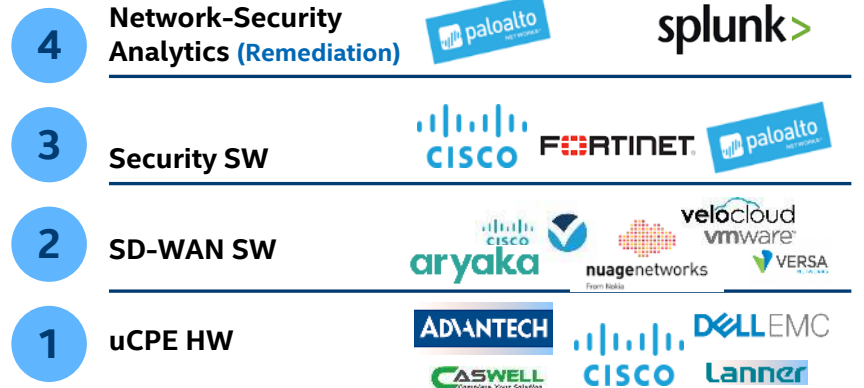
vAppliance on Compute VNFs



COTS Server



uCPE with Virtualized Appliances





Intel® Network Builders Insights

CPU Solutions

Products Key Value Vectors

Intel® Xeon® E3

- Excellent Single Threaded Performance
- Integrated Graphics
- Socket Flexibility (LGA/BGA)

Intel® Xeon® D SoC

- Intel® Xeon® Core, Best socket Perf/Watt
- Lower Power, Higher Physical Density
- Larger (up to 512GB) memory capacity
- Integrated Crypto Compression
- One Chip Solution, BGA with integrated 10GbE

Intel Atom® SoC

- Intel Atom® Core
- Lowest Power, Highest Physical Density**
- Integrated Crypto/Compression
- One chip solution, BGA with integrated 10GbE

Address the increasing segmentation of workload requirements.

*When compared to Intel® Xeon® E3

**When compared to Intel® Xeon® D

Intel® Xeon® Processor D Product Cadence

Future
Intel® Xeon®-D *

Intel® Xeon®
Processor D-2100

Intel® Xeon® Processor
D-1600

Intel® Xeon® Processor
D-1500 NS

Intel® Xeon®
Processor D-1500
Product Family

Density

Integration

Acceleration

- *Product in Planning
- ** Intel® QuickAssist Technology

Intel Atom® Processor Product Cadence

Future Intel Atom®
Processor*

Intel Atom® C3000 Refresh
Space/Power Optimized

Intel Atom® C3000 Family
Space/Power Optimized

Intel Atom® C2000 Family
Lightweight Processing

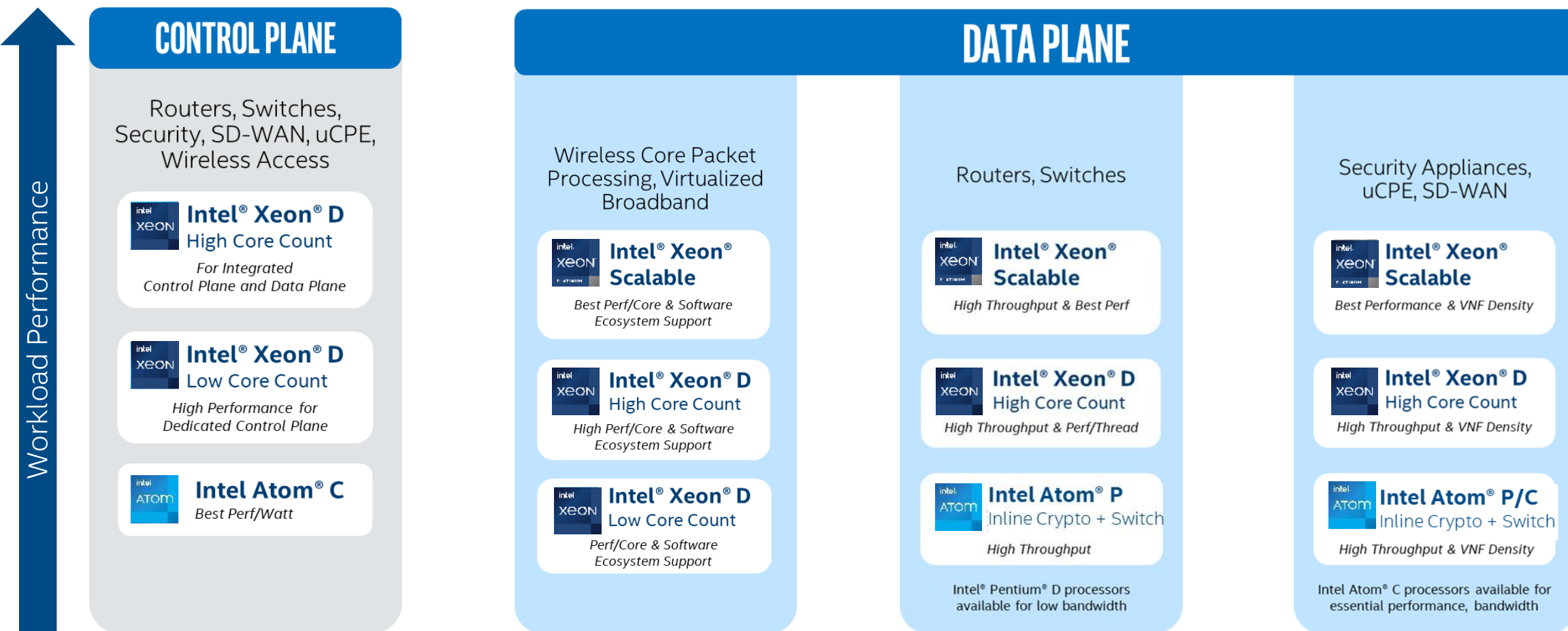
Density

Integration

Acceleration






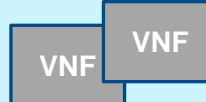

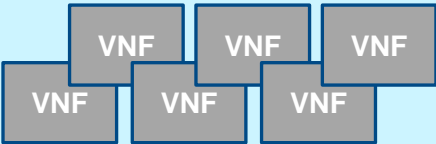
- *Product in Planning
- ** Intel® QuickAssist Technology

SOC positioning for network workloads



All comparisons and performance claims are being made between the 3 Intel product families shown

Deployment Models and Segmentation

VNFS @ POP/DATA CENTER	Routing, vFW, IPS, SBC, CGNAT, WiFi CTRL, SD-WAN CTRL	Routing, IPS, SBC, CGNAT, WiFi CTRL, SD-WAN CTRL	IPS, CGNAT, SBC, WiFi CTRL, SD-WAN CTRL	CGNAT, SBC, SD-WAN CTRL
SERVICE PROVIDER / ENTERPRISE	 SOHO (Thin)	 Small Branch	 Medium Branch	 Large Branch (Thick)
VNFS @ CPE	SD-WAN	SD-WAN, vFW	SD-WAN, Routing, vFW, WAN Accel	SD-WAN, Routing, vFW, WiFi CTRL, WAN Accel, IPS
INTEL® TECHNOLOGIES TO DRIVE PERFORMANCE, SCALE, & SECURITY	 1 VNF / Bare Metal	 1-2 VNFs	 2-4 VNFs	 4+ VNFs
	Intel Atom® Processors (2-core to 4-core)	Intel Atom® Processors (2-core to 8-core)	Intel Atom® Processors (8-core to 16-core) Intel® Xeon® D Processors	Intel® Xeon® D Processors Intel® Xeon® Scalable Processors
	<ul style="list-style-type: none"> • Data Plane Developer Kit • Intel® QuickAssist Technology • Hyperscan 	<ul style="list-style-type: none"> • Intel® Virtualization Technology • Intel® AES New Instructions • Intel® Trusted Execution Tech. 	<ul style="list-style-type: none"> • Intel® Platform Trust Technology • Intel® Secure Device Onboard (SDO) • OpenVINO 	

Summary

- Intel is investing in network transformation
- Comprehensive suite of products and technologies that enable differentiated Edge solutions
- Rich ecosystem of uCPE/Edge vendors and technology partners to deliver best in class products



Collateral

These can all be found in the attachments tab below your viewer

- For SKUs, see ark.intel.com
- For Product Snapshots, please contact xiaojun.li@intel.com
- For Product Datasheets, see
<https://www.intel.com/content/www/us/en/products/processors/atom/c-series.html>
<https://www.intel.com/content/www/us/en/products/processors/xeon/d-processors.html>

Questions?

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The Intel logo is centered on a solid blue background. It features the word "intel" in a white, lowercase, sans-serif font. A small, light blue square is positioned above the letter "i". To the right of the word "intel" is a small white registered trademark symbol (®).

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